

HSF

NOTES:

Current Rating:1.5AMP
 Contact Resistance:20mΩ max
 Withstand Voltage:500V AC/DC
 Insulation Resistance:1000MΩ min
 Operation Temperature:-40°C to +105°C

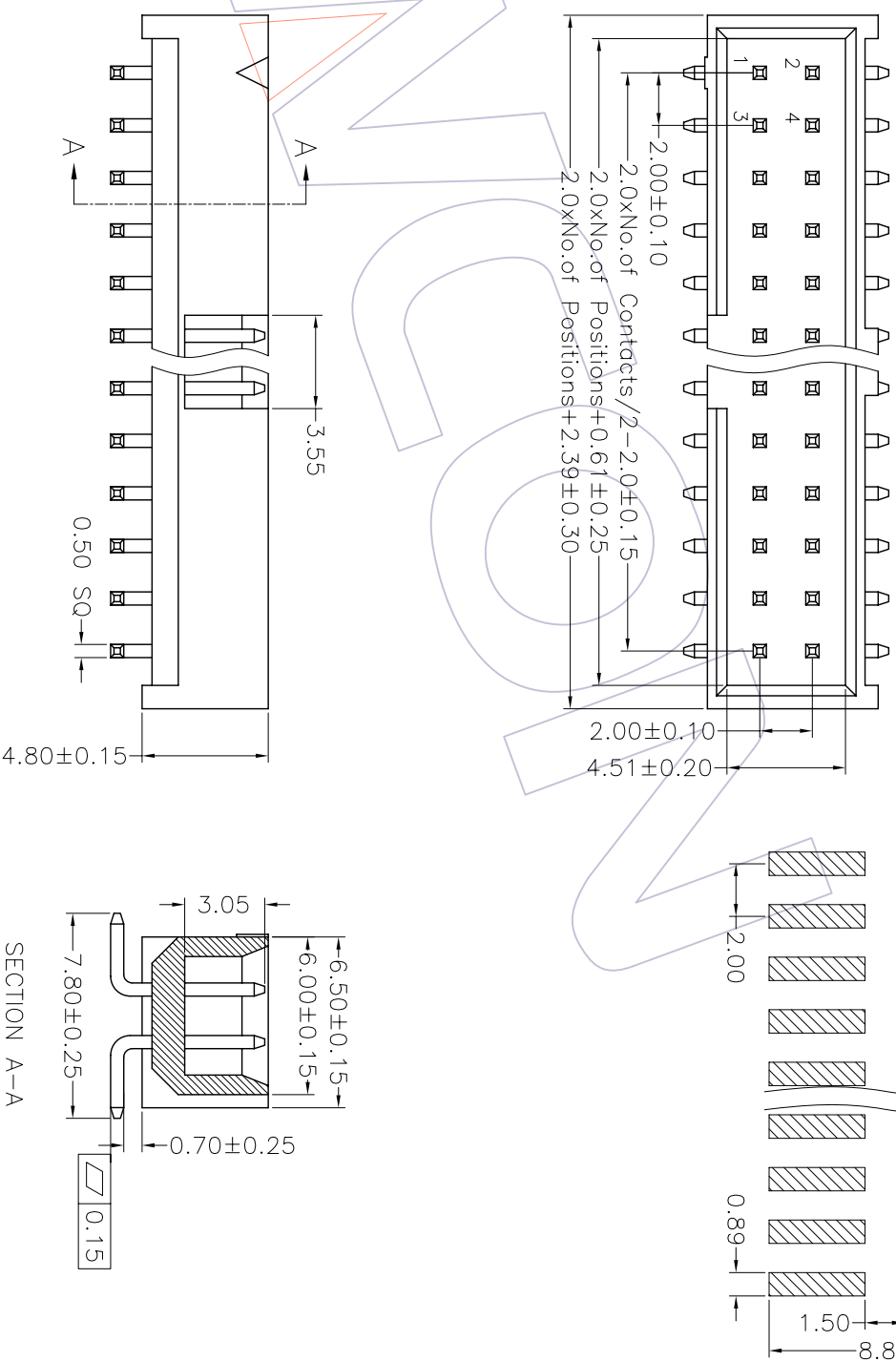
Contact Material:Brass
 Contact plating:Au or Sn Over Ni
 Insulator Material:LCF+30%GF(UL94V-0)

Ordering Information

3124-XX M XX B K00 X 2

No.of Pins	Contact Plating	Color Insulator	Packing
10 30	G0=Gold Flash	B=Black	T=Tube
14 34	G1=3u"Gold	U=Blue	P=Tube+CAP
16 40	G2=5u"Gold	W=White	R=Tape&Reel+CAP
20 44	G3=10u"Gold		
24 50	G4=15u"Gold		
26 60	G5=30u"Gold		

S0=Gold Flash/Tin
 S1=3u"Gold/Tin
 S2=5u"Gold/Tin
 S3=10u"Gold/Tin
 S4=15u"Gold/Tin
 S5=30u"Gold/Tin
 SN=Tin



Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)

REV	DATE	MODIFICATION DESCRIPTION	CHANGE	APPROVE	OPERATION	DRAW	WEIXD	SCALE	PART NO.
A0	08/05/06	NEW			OPERATION X.X ±0.40 X.XX ±0.25 X.XXX ±0.15 Angle ± 3'	DESIGN CHECK	08/05/06	4:1 mm A4	3124-XXMXXBK00X2
					DIM	APPROVE		PROJ.	TITLE: Customer NO.

WCON 维峰五金电子有限公司
 WAFER HARDWARE ELECTRONICS CO.,LTD

2.00 BOX HEADER SMT H=4.8
 SMTPEC(SHORT TYPE)